

# PC4SF21YVZ Series

\*Non-zero cross type is also available. (**PC4SF11YVZ Series**)

V<sub>DRM</sub>: 800V, Reinforced insulation type Zero cross type DIP 6pin Phototriac Coupler for triggering



#### ■ Description

**PC4SF21YVZ Series** reinforced insulation type Phototriac Coupler include an infrared emitting diode (IRED) optically coupled to an output Phototriac.

These devices feature full wave control and are ideal isolated drivers for medium to high current Triacs.

DIP package provides 5.0kV isolation from input to output with superior commutative noise immunity.

#### ■ Features

- 1. High repetitive peak off-state voltage (V<sub>DRM</sub>: 800V)
- 2. Zero crossing functionality (Vox: MAX. 20V)
- 3. I<sub>FT</sub> ranks available (see Model Line-up section in this datasheet)
- 4. 6 pin DIP package
- 5. Reinforced insulation type (MIN. 0.4mm internal separation)
- 6. Superior noise immunity (dV/dt : MIN. 500V/μs)
- 7. Lead-free components are also available (see Model Line-up section in this datasheet)
- 8. Double transfer mold construction (Ideal for Flow Soldering)
- High isolation voltage between input and output (V<sub>iso</sub>(rms): 5.0kV)

#### ■ Agency approvals/Compliance

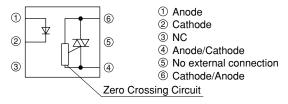
- Recognized by UL1577 (Double protection isolation), file No. E64380 (as model No. 4SF21)
- 2. Approved by CSA, file No. CA95323 (as model No. **4SF21**)
- 3. Approved by BSI: BS-EN60065, file No. 6690/BS-EN60950, file No. 7421, (as model No. **4SF21**)
- Approved by SEMKO, EN60065/EN60950, file No. 0033029 (as model No. 4SF21)
- Approved by DEMKO, EN60065/EN60950, file No. 310107 (as model No. 4SF21)
- Approved by FIMKO, EN60065/EN60950, file No. 15795 (as model No. 4SF21)
- 7. Approved by VDE (\*)(DIN EN 60747-5-2), file No. 40008189 (as model No. **4SF21**)
- 8. Package resin: UL flammability grade (94V-0)
  - (\*) DIN EN60747-5-2 : successor standard of DIN VDE0884 Up to Date code "RD" (December 2003), approval of DIN VDE0884.
    - From Date code "S1" (January 2004), approval of DIN EN60747-5-2.

#### ■ Applications

- Triggering for Triacs used to switch on and off devices which require AC Loads.
  - For example heaters, fans, motors, solenoids, and valves.
- 2. AC line control in power supply applications.

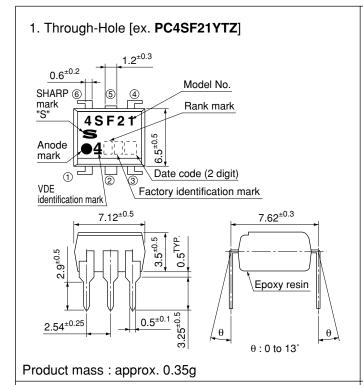


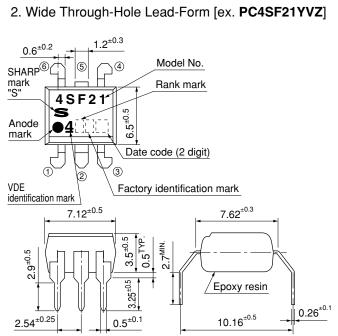
#### ■ Internal Connection Diagram



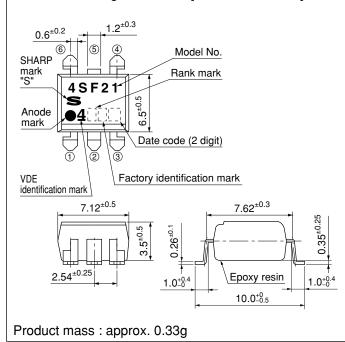
#### **■** Outline Dimensions

(Unit: mm)



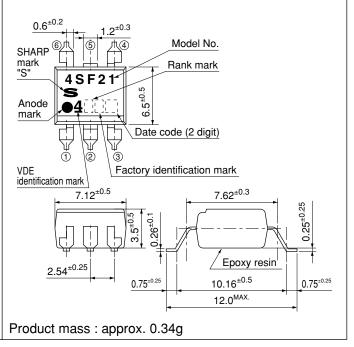


#### 3. SMT Gullwing Lead-Form [ex. PC4SF21YXP]



#### 4. Wide SMT Gullwing Lead-Form [ex. PC4SF21YWP]

Product mass: approx. 0.35g



\*Pin 5 is not allowed external connection

Sheet No.: D2-A08301EN



# Date code (2 digit)

	1st o	digit		2nd digit		
	Year of p	roduction		Month of production		
A.D.	Mark	A.D	Mark	Month	Mark	
1990	A	2002	P	January	1	
1991	В	2003	R	February	2	
1992	С	2004	S	March	3	
1993	D	2005	T	April	4	
1994	Е	2006	U	May	5	
1995	F	2007	V	June	6	
1996	Н	2008	W	July	7	
1997	J	2009	X	August	8	
1998	K	2010	A	September	9	
1999	L	2011	В	October	0	
2000	M	2012	С	November	N	
2001	N	:	:	December	D	

repeats in a 20 year cycle

# Factory identification mark

Factory identification Mark	Country of origin
no mark	Iomon
	Japan
	Indonesia
$\overline{\hspace{1cm}}$	Philippines
_	China

<sup>\*</sup> This factory marking is for identification purpose only.

Please contact the local SHARP sales representative to see the actural status of the production.

Rank mark

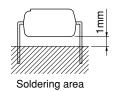
Refer to the Model Line-up table



# ■ Absolute Maximum Ratings

 $(T_a=25^{\circ}C)$ 

		_	(1a 25 C)	
	Parameter	Symbol	Rating	Unit
T4	Forward current	$I_F$	50	mA
Input	Reverse voltage	$V_R$	6	V
	RMS ON-state current	I <sub>T</sub> (rms)	0.1	A
Output	Peak one cycle surge current	I <sub>surge</sub>	1.2 *3	A
	Repetitive peak OFF-state voltage	$V_{DRM}$	800	V
*1 Isolatio	on voltage	V <sub>iso</sub> (rms)	5.0	kV
	ing temperature	Topr	-30 to +100	°C
Storag	e temperature	$T_{stg}$	-55 to +125	°C
*2 Solder	ing temperature	T <sub>sol</sub>	270 *4	°C



# **■** Electro-optical Characteristics

 $(T_a=25^{\circ}C)$ 

	Parameter			Conditions	MIN.	TYP.	MAX.	Unit
T	Forward voltage		$V_F$	I <sub>F</sub> =20mA	_	1.2	1.4	V
Input	Reverse current		$I_R$	$V_R=3V$	_	1	10	μΑ
	Repentitive peak OFF-state	current	$I_{DRM}$	$V_D = V_{DRM}$	_	1	3	μΑ
	ON-state voltage		$V_{T}$	$I_{T}=0.1A$	_	_	2.5	V
Outmut	Holding current		$I_{H}$	$V_D=4V$	0.1	_	3.5	mA
Output	Critical rate of rise of OFF-state voltage		dV/dt	$V_D=1/\sqrt{2} \cdot V_{DRM}$	500	1 000	-	V/µs
	Zero cross voltage	Rank B	V <sub>ox</sub>	I <sub>F</sub> =15mA, Resistance load			20	V
		Rank C		I <sub>F</sub> =8mA, Resistance load	_	_	20	
	Minimovan tri agan ayamant	Rank B	т	$V_{D}=4V, R_{I}=100\Omega$	_	_	7	mA
Transfer	Minimum trigger current	Rank C	$I_{FT}$	V <sub>D</sub> =4 V, K <sub>L</sub> =10052	_	_	5	
charac- teristics	Isolation resistance	Isolation resistance		DC500V,40 to 60%RH	5×10 <sup>10</sup>	$10^{11}$	_	Ω
teristics	Turn-on time		t <sub>on</sub>	$V_D=4V, R_L=100\Omega, I_F=20mA$	-	_	50	μs

<sup>\*1 40</sup> to 60%RH, AC for 1minute, f=60Hz \*2 For 10s

<sup>\*3</sup> f=50Hz sine wave

<sup>\*4</sup> Lead solder plating models: 260°C



# ■ Model Line-up (1) (Lead-free components)

Lead Form	Throug	gh-Hole	SMT G	ullwing	Wide Thr	ough-Hole		
Chinaina Daalaaa				Rank mark	I <sub>FT</sub> [mA]			
Shipping Package					$(V_D=4V,$			
DIN		Approved		Approved		Approved		$R_L=100\Omega$ )
EN60747-5-2		Approved		Approved		Approved		
Model No.		PC4SF21YTZBF		PC4SF21YXZBF		PC4SF21YVZBF	В	MAX.7
Wiodei No.		PC4SF21YTZCF		PC4SF21YXZCF		PC4SF21YVZCF	С	MAX.5

Lead Form	Wide SM	Γ Gullwing	SMT Gullwing Wide SMT Gullwing					
OI: : D 1	Sleeve		Taping					I <sub>FT</sub> [mA]
Shipping Package	50pcs/sleeve		1 000pcs/reel				Rank mark	$(V_D=4V,$
DIN		Annroyad		Annayad		Annroyad		$R_L=100\Omega)$
EN60747-5-2		Approved		Approved		Approved		
Model No.		PC4SF21YWZBF		PC4SF21YXPBF		PC4SF21YWPBF	В	MAX.7
wiodel No.		PC4SF21YWZCF		PC4SF21YXPCF		PC4SF21YWPCF	С	MAX.5

# ■ Model Line-up (2) (Lead solder plating components)

Lead Form	Throug	gh-Hole	SMT Gullwing Wide Through-Hole					
Chinaina Darlessa	Sleeve							I <sub>FT</sub> [mA]
Shipping Package				Rank mark	$(V_D=4V,$			
DIN EN60747-5-2		Approved		Approved		Approved		$R_L=100\Omega$ )
Model No.		PC4SF21YTZB		PC4SF21YXZB		PC4SF21YVZB	В	MAX.7
		PC4SF21YTZC		PC4SF21YXZC		PC4SF21YVZC	C	MAX.5

Lead Form	Wide SMT Gullwing		SMT G	SMT Gullwing Wide SMT G		Γ Gullwing		
CI: D I	Sleeve		Taping					I <sub>FT</sub> [mA]
Shipping Package	50pcs/sleeve		1 000pcs/reel				Rank mark	$(V_D=4V,$
DIN EN60747-5-2		Approved		Approved		Approved		$R_L=100\Omega$ )
Model No.		PC4SF21YWZB		PC4SF21YXPB		PC4SF21YWPB	В	MAX.7
wiodel No.		PC4SF21YWZC		PC4SF21YXPC		PC4SF21YWPC	С	MAX.5

Please contact a local SHARP sales representative to inquire about production status.



Fig.1 Forward Current vs. Ambient Temperature

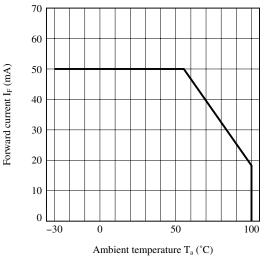


Fig.3 Forward Current vs. Forward Voltage

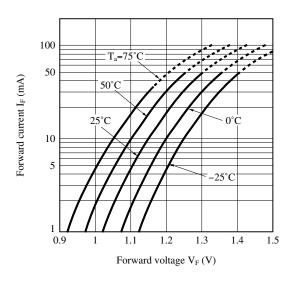


Fig.5 Relative Repetitive Peak OFF-state Voltage vs. Ambient Temperature

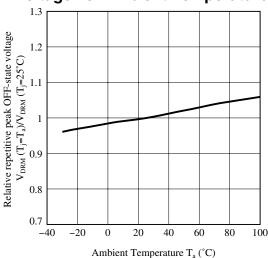


Fig.2 RMS ON-state Current vs.
Ambient Temperature

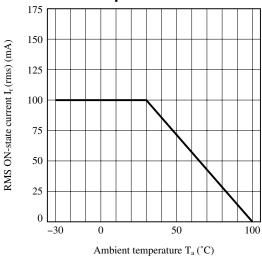


Fig.4 Minimum Trigger Current vs.
Ambient Temperature

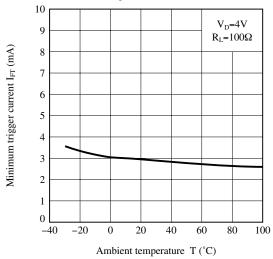
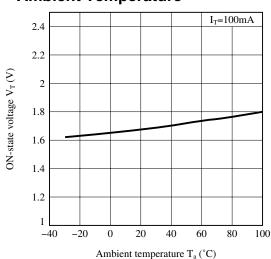


Fig.6 ON-state Voltage vs.
Ambient Temperature



Sheet No.: D2-A08301EN



Fig.7 Holding Current vs.

Ambient Temperature

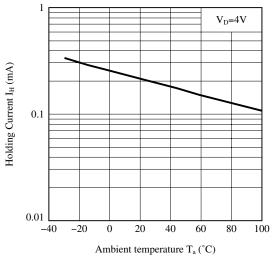


Fig.9 Turn-on Time vs. Forward Current

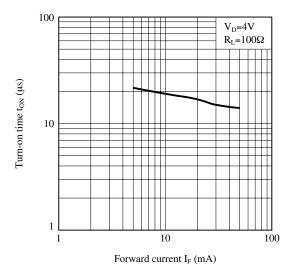


Fig.10-b Zero-cross Voltage vs. Ambient Temperature (Rank C)

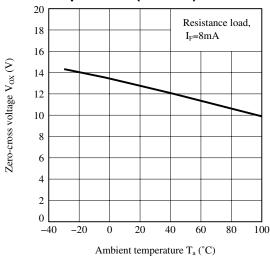


Fig.8 Repetitive Peak OFF-state Current vs. Ambient Temperature

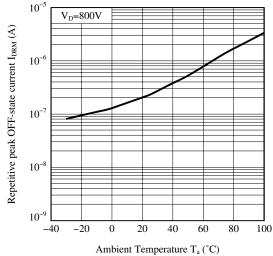
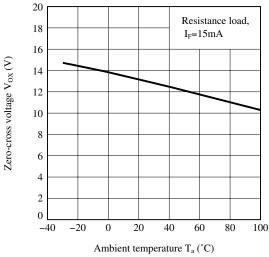


Fig.10-a Zero-cross Voltage vs. Ambient Temperature (Rank B)



Remarks: Please be aware that all data in the graph are just for reference.



#### ■ Design Considerations

#### Design guide

In order for the Phototriac to turn off, the triggering current (I<sub>F</sub>) must be 0.1mA or less.

Please refrain from using these devices in a direct drive configuration. These Phototriac Coupler are intended to be used as triggering device for main Triacs. Please ensure that the output rating of these devices will be sufficient for triggering the main output Triac of your choice. Failure to do may result in malfunctions.

For applications with inductive loads such as motors, please use caution in utilizing a zero crossing type Phototraiac Coupler as this may cause undesired operations due to the phase difference between voltage and current of load.

For designs that will experience excessive noise or sudden changes in load voltage, please include an appropriate snubber circuit as shown in the below circuit. Please keep in mind the Sharp Phototriac Coupler incorporate superrior dV/dt ratings which can eliminate the need for a snubber circuit.

For over voltage protection, a Varistor may be used.

#### Degradation

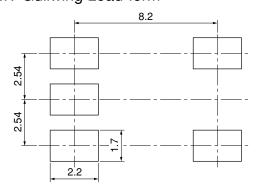
In general, the emission of the IRED used in Phototriac Couplers will degrade over time.

In the case where long term operation and / or constant extreme temperature fluctuations will be applied to the devices, please allow for a worst case scenario of 50% degradation over 5years.

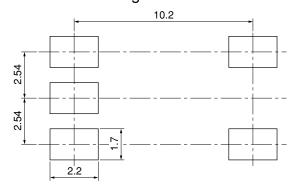
Therefore in order to maintain proper operation, a design implementing these Phototriac Couplers should provide at least twice the minimum required triggering current from initial operation.

#### Recommended Foot Print (reference)

SMT Gullwing Lead-form



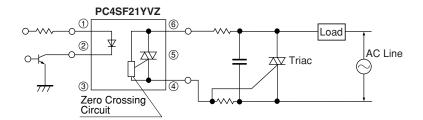
Wide SMT Gullwing Lead-form



(Unit:mm)



# ● Standard Circuit (Medium/High Power Triac Drive Circuit)



Note) Please add the snubber circuit according to a condition.

Any snubber or varistor used for the above mentioned scenarios should be located as close to the main output triac as possible.

<sup>☆</sup> For additional design assistance, please review our corresponding Optoelectronic Application Notes.



#### ■ Manufacturing Guidelines

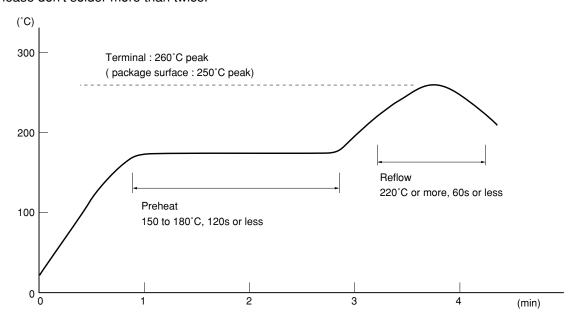
## Soldering Method

#### Reflow Soldering:

Reflow soldering should follow the temperature profile shown below.

Soldering should not exceed the curve of temperature profile and time.

Please don't solder more than twice.



#### Flow Soldering:

Due to SHARP's double transfer mold construction submersion in flow solder bath is allowed under the below listed guidelines.

Flow soldering should be completed below 270°C and within 10s.

Preheating is within the bounds of 100 to 150°C and 30 to 80s.

Please don't solder more than twice.

#### Hand soldering

Hand soldering should be completed within 3s when the point of solder iron is below 400°C.

Please don't solder more than twice.

#### Other notices

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.



#### Cleaning instructions

#### Solvent cleaning:

Solvent temperature should be 45°C or below. Immersion time should be 3minutes or less.

#### Ultrasonic cleaning:

The impact on the device varies depending on the size of the cleaning bath, ultrasonic output, cleaning time, size of PCB and mounting method of the device.

Therefore, please make sure the device withstands the ultrasonic cleaning in actual conditions in advance of mass production.

#### Recommended solvent materials:

Ethyl alcohol, Methyl alcohol and Isopropyl alcohol.

In case the other type of solvent materials are intended to be used, please make sure they work fine in actual using conditions since some materials may erode the packaging resin.

#### Presence of ODC

This product shall not contain the following materials.

And they are not used in the production process for this device.

Regulation substances: CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform)

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.



#### ■ Package specification

#### Sleeve package

#### 1. Through-Hole or SMT Gullwing

Package materials

Sleeve: HIPS (with anti-static material)

Stopper: Styrene-Elastomer

#### Package method

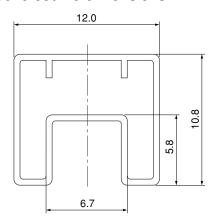
MAX. 50pcs of products shall be packaged in a sleeve.

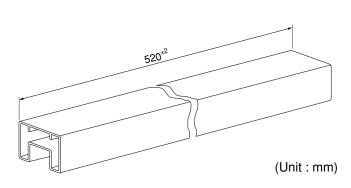
Both ends shall be closed by tabbed and tabless stoppers.

The product shall be arranged in the sleeve with its anode mark on the tabless stopper side.

MAX. 20 sleeves in one case.

#### Sleeve outline dimensions





## 2. Wide Through-Hole or Wide SMT Gullwing

Package materials

Sleeve: HIPS (with anti-static material)

Stopper: Styrene-Elastomer

#### Package method

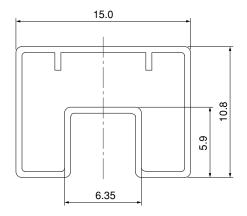
MAX. 50pcs of products shall be packaged in a sleeve.

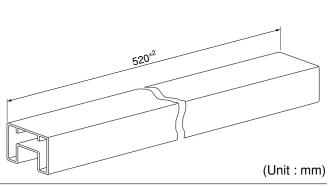
Both ends shall be closed by tabbed and tabless stoppers.

The product shall be arranged in the sleeve with its anode mark on the tabless stopper side.

MAX. 20 sleeves in one case.

#### Sleeve outline dimensions





Sheet No.: D2-A08301EN



## ● Tape and Reel package

# 1. SMT Gullwing

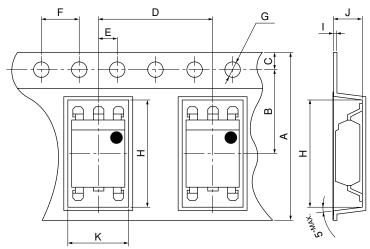
Package materials

Carrier tape: A-PET (with anti-static material)

Cover tape: PET (three layer system)

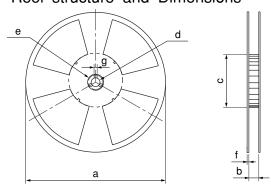
Reel: PS

### Carrier tape structure and Dimensions



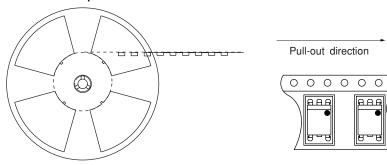
Dimensions List (								
A	В	С	D	Е	F	G		
16.0±0.3	7.5 <sup>±0.1</sup>	1.75 <sup>±0.1</sup>	12.0 <sup>±0.1</sup>	2.0±0.1	4.0 <sup>±0.1</sup>	φ1.5 <sup>+0.1</sup>		
Н	I	J	K					
10.4±0.1	0.4±0.05	4.2±0.1	7.8 <sup>±0.1</sup>					

#### Reel structure and Dimensions



Dimensio	ns List	(Unit: mm)			
a	b	c	d		
330	17.5 <sup>±1.5</sup>	100±1.0	13±0.5		
e	f	g			
23±1.0	2.0±0.5	2.0±0.5			

# Direction of product insertion



[Packing: 1 000pcs/reel]



#### 2. Wide SMT Gullwing

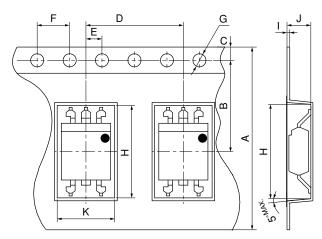
Package materials

Carrier tape: A-PET (with anti-static material)

Cover tape: PET (three layer system)

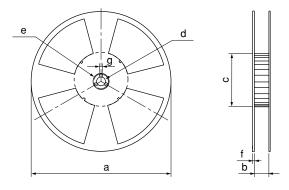
Reel: PS

# Carrier tape structure and Dimensions



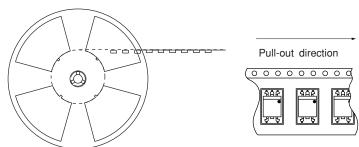
Dimension	(Unit: mm)						
A	В	С	D	Е	F	G	
24.0±0.3	11.5 <sup>±0.1</sup>	1.75 <sup>±0.1</sup>	12.0 <sup>±0.1</sup>	2.0 <sup>±0.1</sup>	4.0 <sup>±0.1</sup>	φ1.5 <del>+</del> 0.1	
Н	I	J	K				
12.2±0.1	0 4±0.05	4 15±0.1	7 6±0.1				

#### Reel structure and Dimensions



Dimensio	ns List	(Unit: mm)			
a	b	c	d		
330	25.5 <sup>±1.5</sup>	100±1.0	13±0.5		
e	f	g			
23 <sup>±1.0</sup>	2.0 <sup>±0.5</sup>	2.0 <sup>±0.5</sup>			

## Direction of product insertion



[Packing: 1 000pcs/reel]



#### ■ Important Notices

- · The circuit application examples in this publication are provided to explain representative applications of SHARP devices and are not intended to guarantee any circuit design or license any intellectual property rights. SHARP takes no responsibility for any problems related to any intellectual property right of a third party resulting from the use of SHARP's devices.
- · Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device. SHARP reserves the right to make changes in the specifications, characteristics, data, materials, structure, and other contents described herein at any time without notice in order to improve design or reliability. Manufacturing locations are also subject to change without notice.
- · Observe the following points when using any devices in this publication. SHARP takes no responsibility for damage caused by improper use of the devices which does not meet the conditions and absolute maximum ratings to be used specified in the relevant specification sheet nor meet the following conditions:
- (i) The devices in this publication are designed for use in general electronic equipment designs such as:
  - --- Personal computers
  - --- Office automation equipment
  - --- Telecommunication equipment [terminal]
  - --- Test and measurement equipment
  - --- Industrial control
  - --- Audio visual equipment
  - --- Consumer electronics
- (ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection

with equipment that requires higher reliability such as:

- --- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- --- Traffic signals
- --- Gas leakage sensor breakers
- --- Alarm equipment
- --- Various safety devices, etc.
- (iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:
  - --- Space applications
  - --- Telecommunication equipment [trunk lines]
  - --- Nuclear power control equipment
  - --- Medical and other life support equipment (e.g., scuba).
- · If the SHARP devices listed in this publication fall within the scope of strategic products described in the Foreign Exchange and Foreign Trade Law of Japan, it is necessary to obtain approval to export such SHARP devices.
- · This publication is the proprietary product of SHARP and is copyrighted, with all rights reserved. Under the copyright laws, no part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, for any purpose, in whole or in part, without the express written permission of SHARP. Express written permission is also required before any use of this publication may be made by a third party.
- Contact and consult with a SHARP representative if there are any questions about the contents of this publication.